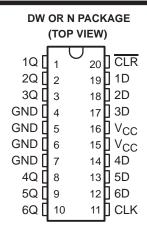
74AC11174 HEX D-TYPE FLIP-FLOP WITH CLEAR

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- Applications Include: Buffer/Storage Registers, Shift Registers, Pattern Generators
- Flow-Through Architecture Optimizes PCB Layout
- Center-Pin V_{CC} and GND Pin Configurations Minimize High-Speed Switching Noise
- EPIC[™] (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline Packages and Standard Plastic 300-mil DIPs



description

This device contains six D-type flip-flops and is positive-edge-triggered with a direct clear input. Information at the D inputs meeting the setup time requirements is transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock input is at either the high or low level, the D input signal has no effect at the output.

The 74AC11174 is characterized for operation from – 40°C to 85°C.

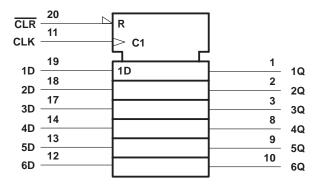
FUNCTION TABLE

	INPUTS		OUTPUT
CLR	CLK	D	Q
L	Х	Χ	L
Н	\uparrow	Н	Н
Н	\uparrow	L	L
Н	L	Χ	QO

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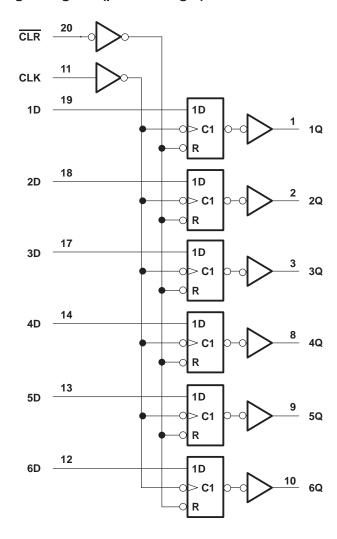


logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Output voltage range, V _O (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through V _{CC} or GND	±150 mA
Storage temperature range	

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.



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recommended operating conditions

			MIN	NOM	MAX	UNIT
VCC	Supply voltage		3	5	5.5	V
		V _{CC} = 3 V	2.1			
V_{IH}	High-level input voltage	$V_{CC} = 4.5 \text{ V}$	3.15			V
		$V_{CC} = 5.5 \text{ V}$	3.85			
		V _{CC} = 3 V			0.9	
V _{IL}	Low-level input voltage	$V_{CC} = 4.5 \text{ V}$			1.35	V
		V _{CC} = 5.5 V			1.65	
٧ _I	Input voltage		0		VCC	V
VO	Output voltage		0		Vcc	V
		V _{CC} = 3 V			-4	
ЮН	High-level output current	V _{CC} = 4.5 V			-24	mA
		V _{CC} = 5.5 V			-24	
		V _{CC} = 3 V			12	
l _{OL}	Low-level output current	V _{CC} = 4.5 V			24	mA
02		V _{CC} = 5.5 V			24	
Δt/Δν	Input transition rise or fall rate		0		10	ns/V
T _A	Operating free-air temperature		-40		85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS		T/	A = 25°C	;	MAINI	MAV	UNIT
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	UNII
		3 V	2.9			2.9		
	$I_{OH} = -50 \mu\text{A}$	4.5 V	4.4			4.4		
		5.5 V	5.4			5.4		
VOH	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		V
		4.5 V	3.94			3.8		
	I _{OL} = -24 mA		4.94			4.8		
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85		
		3 V			0.1		0.1	
	$I_{OL} = 50 \mu\text{A}$	4.5 V			0.1		0.1	
		5.5 V			0.1		0.1	
V_{OL}	I _{OL} = 12 mA	3 V			0.36		0.44	V
	lo 24 mA	4.5 V			0.36		0.44	
	I _{OL} = 24 mA				0.36		0.44	
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V					1.65	
IĮ	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1	μΑ
ICC	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		80	μΑ
C _i	V _I = V _{CC} or GND	5 V		4				pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

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timing requirements over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

			T _A =	T _A = 25°C		MAX	UNIT	
			MIN	MAX	MIN	WAX	UNIT	
fclock	Clock frequency		0	80	0	80	MHz	
t _w Pulse duration	Pulso duration	CLR low	4.5		4.5			
t _w	ruise duration	CLK high or low	6		6		ns	
	Catua tima hafara CLIVA	Data	7		7			
t _{su}	etup time before CLK↑ CLR inactive		1.5		1.5		ns	
t _h	Hold time after CLK↑		0		0		ns	

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

			T _A =	T _A = 25°C		MIN MAX		
			MIN	MAX	IVIIIN	WAX	UNIT	
fclock	Clock frequency		0	100	0	100	MHz	
	Pulse duration	CLR low	4		4			
t _W	CLK high or low		5		5		ns	
	Satura tima hafara CLIVA	Data	4.5		4.5			
t _{su}	Setup time before CLK↑ CLR inactive		1.5		1.5		ns	
t _h	Hold time after CLK↑		0		0		ns	

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T,	Δ = 25°C	;	MINI	MAV	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	IVIIN IVIAA	N MAX	MIN MAX	UNII
f _{max}			80	105		80		MHz	
t _{PHL}	CLR	Any Q	3.9	10	13.5	3.9	14.8	ns	
^t PLH	CLK	Any O	2.4	7.5	9.2	2.4	10.8	ne	
^t PHL		Any Q	3.4	9.6	12.7	3.4	14	ns	

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

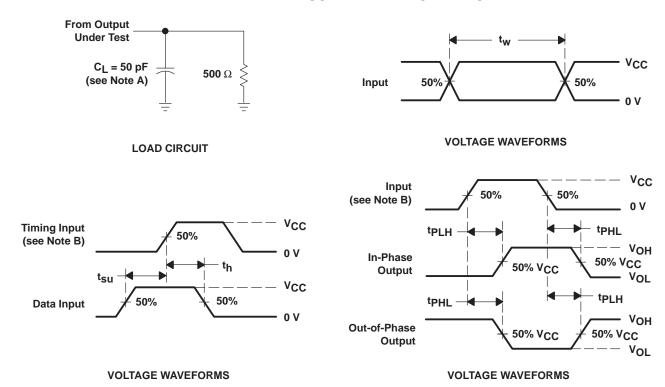
PARAMETER	FROM (INPUT)	TO (OUTPUT)	T _A = 25°C		MIN	MAX	UNIT	
PARAMETER			MIN	TYP	MAX]	IWAX	CIVII
f _{max}			100	125		100		MHz
t _{PHL}	CLR	Any Q	2.9	6.5	9.8	2.9	10.7	ns
t _{PLH}	CLK	Any Q	2.1	4.9	6.8	2.1	7.6	ns
t _{PHL}	OLK	Ally Q	2.7	6.2	9.2	2.7	10.1	115

operating characteristics, V_{CC} = 5 V, T_A = 25°C

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C	Power dissipation capacitance	$C_L = 50 \text{ pF}, f = 1 \text{ MHz}$	29	pF



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \ \Omega$, $t_f = 3 \ ns$, $t_f = 3 \ ns$.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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